Quad 2-input NAND gate BU4011B/BU4011BFV

The BU4011B, BU4011BF, and BU4011BFV are dual-input positive logic NAND gates.

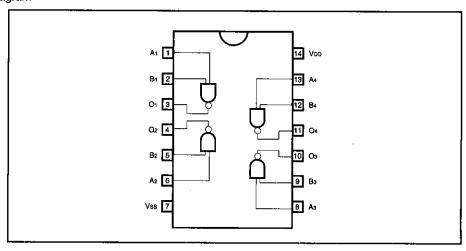
Four circuits are contained on a single chip. An inverter-based buffer has been added to the gate output, enabling improved input/output propagation characteristics, and an increased load capacitance minimizes fluctuation in propagation time.

Features

- 1) Low power consumption.
- 2) Wide operating power supply voltage range.
- 3) High input impedance.

- 4) High fan-out.
- 5) Direct drive of 2 L-TTL inputs and 1 LS-TTL input.

●Block diagram



●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit V	
Power supply voltage	Voo	-0.3~18		
Power dissipation	Pd	1000 (DIP) ,450 (SOP) 350 (SSOP-B14)	mW	
Operating temperature	Topr	−40~85	°C	
Storage temperature	Tstg	− 55~150	°C	
Input voltage	Vin	-0.3~VDD+0.3		

Electrical characteristics

DC characteristics (unless otherwise noted, Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	V _{DD} (V)	Conditions	Measurement Circuit
			<u> </u>					
10.1		3.5	_	_	1	5	1	
High-level input voltage V	ViH	7.0		-	٧	10	_	Fig. 1
	<u> </u>	11.0				15		<u></u>
	ļ	_		1.5	_	5		
Low-level input voltage	VIL	_	_	3.0	V	10	_	Fig. 1
	<u> </u>	_	-	4.0		15		
High-level input current	liн			0.3	μA	15	V _{IH} =15V	Fig. 1
Low-level input current	lı.		_	-0.3	μА	15	V _I L=0V	Fig. 1
High love!		4.95	_			5		,
High-level output voltage	Vон	9.95	_		v	10	lo=0mA	Fig. 1
	<u></u>	14.95	_	_		15]	
Low lovel		_	_	0.05		5		
Low-level output voltage	Vol	_		0.05	v	10	lo=0mA	Fig. 1
		_		0.05	<u> </u>	15		
High-level		-0.16				5	Vон=4.6V	
output current	Іон	-0.4		_	mA	10	Vон=9.5V	Fig. 1
	<u></u>	-1.2	_		<u> </u>	15	Vон=13.5V	
Low-level		0.44		-		5	Vo∟≕0.4V	
output current lou	lou	1.1	_		mA	10	Vo∟=0.5V	Fig. 1
·	'	3.0	-	_	1	15	Vol=1.5V	
Outcomet		_	_	1		5		_
Quiescent supply current	loo	_		2	μА	10	Vi=VDD or GND	
очрру сипопі	'	_		4		15		

Switching characteristics (unless otherwise noted, Ta=25 $^{\circ}$ C, Vss=0V, CL=50pF)

Parameter	Symbol	Min.	Тур.	Max.	Unit.	V _{DD} (V)	Conditions	Measurement Circuit
Output rise time true		_	180	_	ns	5	_	Fig. 2
	tтьн	_	90	-		10		
		_	65	_		15		
Output fall time tтнь		_	100	_	ns	5	_	Fig. 2
	tтнь	Ī.	50	_		10		
		_	40	_		15		
"L" to "H" Propagation delay time		_	90	_		5		
	· –	50	_	ns	10	_	Fig. 2	
		_	40	_		15		
"H" to "L" Propagation delay time		_	90	_	ns	5	_	Fig. 2
	t PHL	_	50	_		10		
		_	40	_		15		
Input capacitance	Cin		5		pF	_	- '	

Measurement circuits

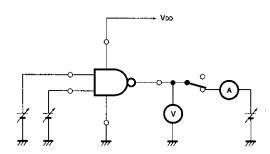


Fig. 1 DC characteristics measurement circuit

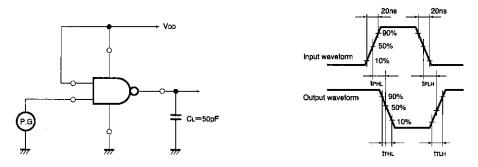


Fig. 2 Switching characteristics measurement circuit



CMOS logic



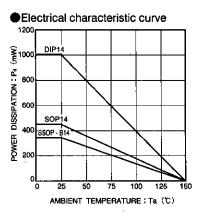
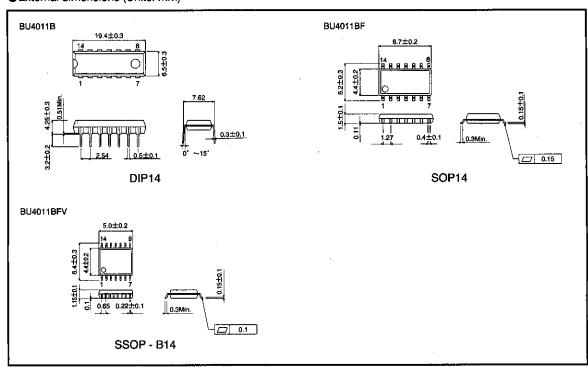


Fig. 3 Power dissipation - Ta characteristic

External dimensions (Units: mm)



Series Standard BU4000B

The BU4000 Series are CMOS ICs featuring low voltage and low power consumption. The wide range of operating power supply voltages is compatible with the general-purpose 4000B Series, and when a 5V power supply voltage is used, the LS-TTL IC can be driven directly.

These ICs are available in SOP and SSOP packages as well as the standard DIP package.

Features

1) Low power consumption.

- High fan-out.
- 2) Wide range of operating power supply voltages.
- 5) Direct drive of 2 L-TTL inputs and 1 LS-TTL input.

3) High input impedance.

●Absolute maximum ratings (Ta = 25℃)

Parameter	Symbol	Limits	Unit
Power supply voltage	Voo	18 *1	V
Input voltage	Vin	-0.3~Vpp+0.3	V
Power dissipation *2	Pd	Please refer to specifications for individual package	mW
Storage temperature	Tstg	−55~150	င

^{*1} For the BU4XXXBC type, Voc = 20 V.

●Recommended operating conditions (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Power supply voltage	VDD	3~16*	V
Input voltage	Vin	0∼Vpp	V
Operating temperature	Topr	−40~85	c

^{*} For the BU4XXXBC type, Von = 3 to 18 V.

●Electrical characteristic curves

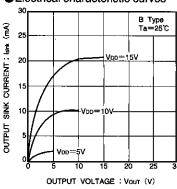


Fig.1 Output sink current - output voltage characteristic

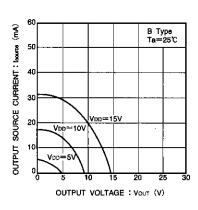


Fig.2 Output source current - output voltage characteristic

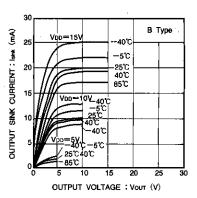


Fig.3 Output SINK current - output voltage characteristic

^{*2} The values for the SOP and SSOP packages are the values when mounted on a glass epoxy PCB (50 mm x 50 mm x 1.6 mm).

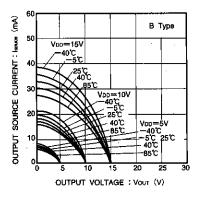


Fig.4 Output source current - output voltage characteristic

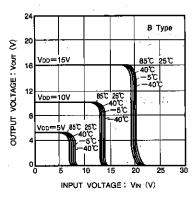


Fig.5 Output voltage - input voltage characteristic

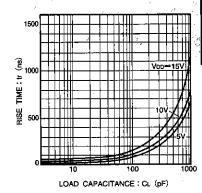


Fig.6 Rise time - load capacitance characteristic

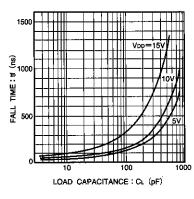


Fig.7 Fall time - load capacitance characteristic

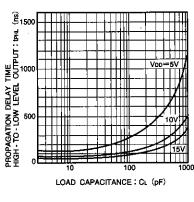


Fig.8 "H" to "L" propagation delay time load capacitance characteristic

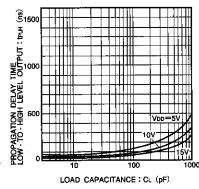


Fig.9 "L" to "H" propagation delay time - load capacitance characteristic

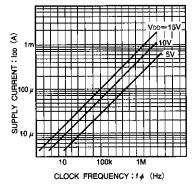


Fig.10 Supply current - clock frequency characteristic

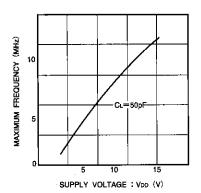


Fig.11 Maximum clock frequency - power supply voltage characteristic

BU4000B series

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